

L Number	Hits	Search Text	DB	Time stamp
1	312334	spacer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/25 17:36
2	662	positive adj mold	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/25 17:36
3	116644	photoresist	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/25 17:37
4	1	(positive adj mold) near5 photoresist	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/25 17:38
5	7	(positive adj mold) same photoresist	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/25 17:39
7	0	spacer same (mold near10 positive near10 photoresist)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/25 17:41
6	29	mold near10 positive near10 photoresist	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/25 17:45
8	2	spacer near10 (positive adj mold)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/06/25 17:45